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Vishay Siliconix

# N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}$ ( $\Omega$ ) MAX.	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (TYP.)		
	0.030 at V <sub>GS</sub> = 4.5 V	5.9			
20	0.034 at V <sub>GS</sub> = 2.5 V	5.5	7.7 nC		
	0.041 at V <sub>GS</sub> = 1.8 V	5			

#### **FEATURES**

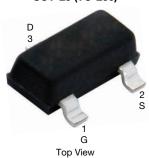
- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> tested

Material categorization:
 For definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>



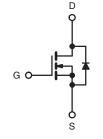
ROHS COMPLIANT HALOGEN FREE

### SOT-23 (TO-236)



### **APPLICATIONS**

- · Load switch
- Power management



N-Channel MOSFET

Marking Code: F5
Ordering Information:

Si2374DS-T1-GE3 (Lead (Pb)-free and Halogen-free)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V <sub>DS</sub>	20	V
Gate-Source Voltage		V <sub>GS</sub>	± 8	
	T <sub>C</sub> = 25 °C		5.9	
Continuous Drain Current /T 150 °C)	T <sub>C</sub> = 70 °C	1 , [	4.7	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	4.5 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C		3.6 <sup>a, b</sup>	Α
Pulsed Drain Current (t = 100 μs)		I <sub>DM</sub>	25	
Continuous Courses Brain Binds Coursest	T <sub>C</sub> = 25 °C	,	1.4	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	0.8 <sup>a, b</sup>	
	T <sub>C</sub> = 25 °C		1.7	
Martin on Brown Black of the	T <sub>C</sub> = 70 °C		1.1	347
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	0.96 <sup>a, b</sup>	W
	T <sub>A</sub> = 70 °C	1	0.62 <sup>a, b</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stq</sub>	-55 to 150	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum Junction-to-Ambient a, c	t ≤ 5 s	$R_{thJA}$	100	130	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	60	75	C/VV

#### **Notes**

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 5 s.
- c. Maximum under steady state conditions is 175 °C/W.
- d.  $T_C = 25$  °C.



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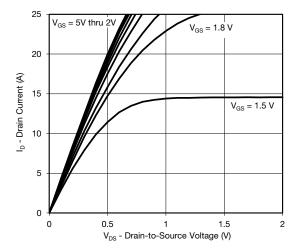
Drain-Source Breakdown Voltage   VDS	- V - mV/°θ - I V 00 nA I μA - A
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	- mV/°( 1 V 00 nA 1 μA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	- mV/°( 1 V 00 nA 1 μA
Vositin Temperature Coefficient   ΔVGS(th)/TJ   Topic State Source Threshold Voltage   Vositin Vosi	mV/°(  I V 00 nA  I μA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	00 nA μΑ
	00 nA I μA
	0 μA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	0 μΑ
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	0
$ \begin{array}{c} \text{Drain-Source On-State Resistance $^a$} & \begin{array}{c} \text{R}_{DS(on)} \\ \text{Drain-Source On-State Resistance $^a$} \\ \end{array} \begin{array}{c} \text{R}_{DS(on)} \\ \end{array} \begin{array}{c} \text{V}_{GS} = 4.5 \text{ V}, \text{I}_D = 4 \text{ A} \\ \end{array} \begin{array}{c} \text{V}_{GS} = 2.5 \text{ V}, \text{I}_D = 3 \text{ A} \\ \end{array} \begin{array}{c} \text{V}_{GS} = 1.8 \text{ V}, \text{I}_D = 2 \text{ A} \\ \end{array} \begin{array}{c} \text{O.0215} \\ \text{O.031} \\ \end{array} \begin{array}{c} \text{O.025} \\ \text{O.031} \\ \text{O.031} \\ \end{array} \begin{array}{c} \text{O.025} \\ \text{O.031} \\ \text{O.031} \\ \end{array} \begin{array}{c} \text{O.025} \\ \text{O.031} \\ O.0$	. А
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	30
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	034 Ω
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	)41
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	- pF
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$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	0
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	2
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	nC
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$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	3
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	3
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	4
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	8
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	0 ns
ajon)	5
	4
Fall Time   t <sub>f</sub>   -   10   2	0
Drain-Source Body Diode Characteristics	
	.4
	5 A
, , , , , , , , , , , , , , , , , , , ,	.2 V
	0 ns
Body Diode Reverse Recovery Charge Q <sub>rr</sub> - 6 1	2 nC
l <sub>F</sub> = 3.6 A, dl/dt = 100 A/μs, I <sub>J</sub> = 25 °C	
Reverse Recovery Rise Time t <sub>b</sub> - 4	ns

## Notes

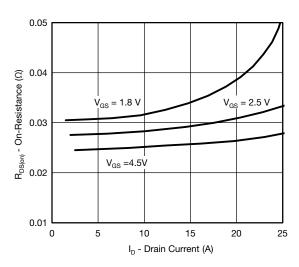
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

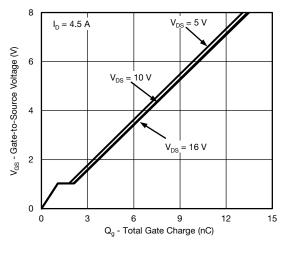




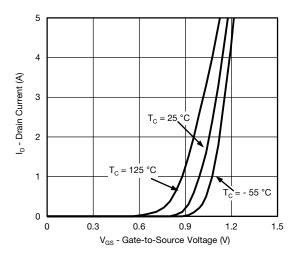
#### **Output Characteristics**



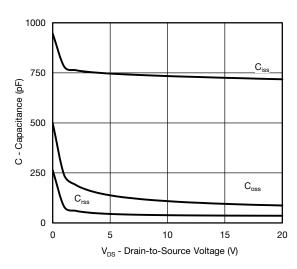
On-Resistance vs. Drain Current and Gate Voltage



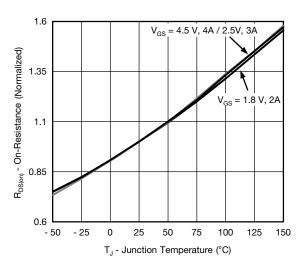
**Gate Charge** 



**Transfer Characteristics** 

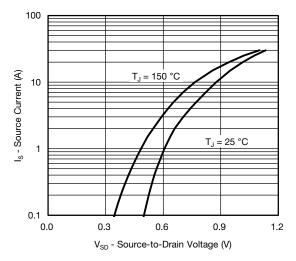


Capacitance

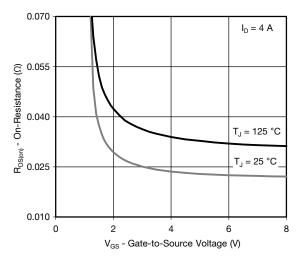


On-Resistance vs. Junction Temperature

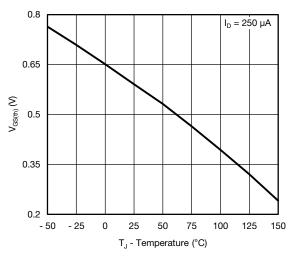




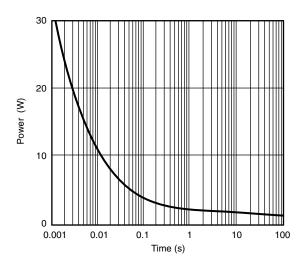
Source-Drain Diode Forward Voltage



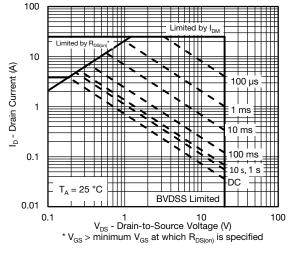
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

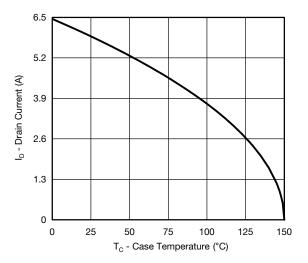


Single Pulse Power (Junction-to-Ambient)

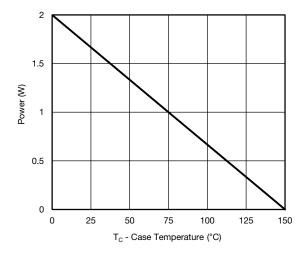


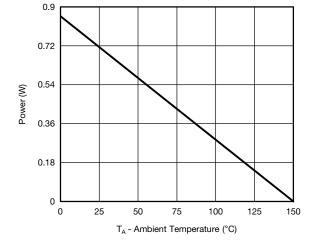
Safe Operating Area, Junction-to-Ambient





#### **Current Derating\***



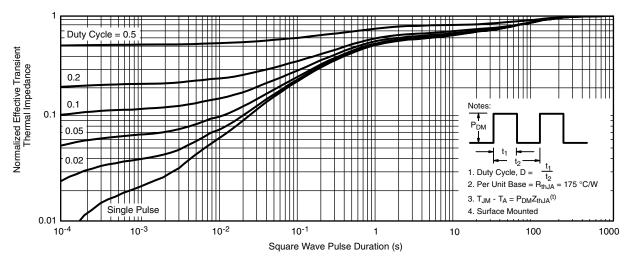


**Power Junction-to-Foot** 

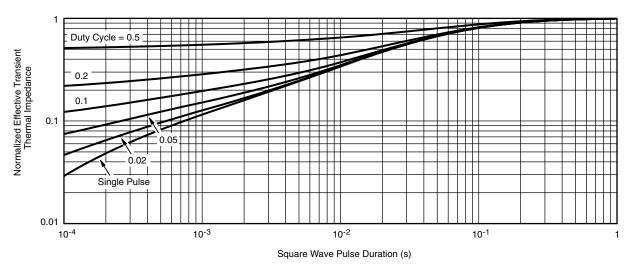
**Power Junction-to-Ambient** 

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J \text{ (max.)}} = 150 \,^{\circ}\text{C}$ , using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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# SOT-23 (TO-236): 3-LEAD







Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
Α	0.89	1.12	0.035	0.044
A <sub>1</sub>	0.01	0.10	0.0004	0.004
A <sub>2</sub>	0.88	1.02	0.0346	0.040
b	0.35	0.50	0.014	0.020
С	0.085	0.18	0.003	0.007
D	2.80	3.04	0.110	0.120
E	2.10	2.64	0.083	0.104
E <sub>1</sub>	1.20	1.40	0.047	0.055
е	0.95 BSC		0.0374 Ref	
e <sub>1</sub>	1.90 BSC		0.0748 Ref	
L	0.40	0.60	0.016	0.024
L <sub>1</sub>	0.64 Ref		0.025 Ref	
S	0.50 Ref		0.020 Ref	
q	3°	8°	3°	8°
ECN: S-03946-Rev. K. 09-	Jul-01			

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01



## **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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